

IEEE 802.3cg 10SPE TF AdHoc meeting July 3rd 2019

Prepared by Peter Jones

Presentations posted at:

<http://www.ieee802.org/3/cg/public/adhoc/index.html>

Agenda/Admin Peter Jones:

Meeting began at 7:05am PT.

1. Reviewed the Attendance information related to the ad hoc(s).
 - a. Reminded participants to indicate full names and employer/affiliation correctly for the meeting minutes.
2. Displayed post-par slide deck, reviewed patent policy, participation conditions.
<https://development.standards.ieee.org/myproject/Public/mytools/mob/slideset.ppt> (10SPE)
<https://mentor.ieee.org/802-ec/dcn/17/ec-17-0093-05-0PNP-ieee-802-participation-slide-ppt.ppt>
3. Made potentially essential patents call for 802.3cg – 10SPE
No-one responded.

Presentations/Discussion.

Chair's announcement of out-of-cycle interim to process 2nd Recirculation: August 14-15 George Zimmerman CME(*)

- Chair announces interim and discusses the schedule towards RevCom

Offer to host out-of-cycle interim – Milwaukee, WI David Brandt Rockwell Automation

- Presenter outlines logistics etc.
- Well received.

Comment 068: 10BASE-T1L PHY State Diagram Changes Steffen Graber Pepperl+Fuchs

- Slides were presented, with Q&A

10BASE-T1L AutoNeg timing changes Steffen Graber Pepperl+Fuchs

- Slides were presented, with Q&A

802.3cg support for PTP/1588/802.1AS

Peter Jones Cisco

- Slides were presented, with Q&A

False Carrier handling in T1S

Piergiorgio Beruto Canovatech

- Slides were presented, with Q&A

Prep for Vienna

George Zimmerman CME(*)

- Presenter outlines schedule for Vienna

Meeting closed – ~8:38am PT

Attendees (from Webex + emails)

Name	Employer	Affiliation	Attended 07/03
Allan Zhu	Huawei	Huawei	y
Amrit Gopal	Ford	Ford	y
Arkadiy Peker	Microsemi	Microsemi	y
Bob Voss	Panduit	Panduit	y
Brett McClellan	Marvell	Marvell	y
Cyrus Kelly	Relcom Inc.	Relcom Inc.	y
David Brandt	Rockwell Automation	Rockwell Automation	y
David Lucia	Sifos	Sifos	y
Dieter Schicketanz	Consultant, Reutlingen University	Consultant, Reutlingen University	y
Doug Oliver	Ford	Ford	y
Egenhofer Ulrich	Draexlmaier	Draexlmaier	y
Eric DiBiaso	TE	TE	y
Geoff Thompson	GraCaSI S.A.	Independent	y
George Zimmerman	CME Consulting	CME Consulting(*)	y
Harald Zweck	Infineon	Infineon	y
Haysam Kadry	Ford	Ford	y
Jim Bauer	Marvell	Marvell	y
John Hess	BelFuse	BelFuse	y
Lars Mickan	Renesas	Renesas	y
Laura Schweitz	Turck	Turck	y
Masood Shariff	CommScope	CommScope	y
Matthias Jaenecke	Yazaki	Yazaki	y
Niall Fitzgerald	acuitas silicon	acuitas silicon	y

Partha Raju	Tektronix	Tektronix	y
Peter Jones	Cisco	Cisco	y
Peter Wu	Marvell	Marvell	y
Piergiorgio Beruto	Canova Tech	Canova Tech	y
Ron Tellas	Belden	Belden	y
Scott Griffiths	Rockwell Automation	Rockwell Automation	y
Steffen Graber	Pepperl+Fuchs	Pepperl+Fuchs	y
Steve Sedio	TDK	TDK	y
Theo Brillhart	Fluke	Fluke	y
Todd Harpel	Berk-Tek	Berk-Tek	y
Venkat Iyer	Microchip	Microchip	y
Attendees			34